PATENT ASSIGNMENT

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SUBMISSION TYPE: **NEW ASSIGNMENT** NATURE OF CONVEYANCE: **ASSIGNMENT**

CONVEYING PARTY DATA

Name	Execution Date
Katsunori MITSUHASHI	03/09/2009
Tetsuya IDE	03/09/2009

RECEIVING PARTY DATA

Name:	ADVANCED LCD TECHNOLOGIES DEVELOPMENT CENTER CO., LTD.	
Street Address:	66-2, Horikawa-cho, Saiwai-ku, Kawasaki-shi	
City:	Kanagawa	
State/Country:	JAPAN	
Postal Code:	212-0013	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12405680

CORRESPONDENCE DATA

Fax Number: (703)413-2220

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (703) 413-3000 tdash@oblon.com Email: Correspondent Name: Oblon, Spivak, et al. Address Line 1: 1940 Duke Street

Address Line 4: Alexandria, VIRGINIA 22314

339891US2 ATTORNEY DOCKET NUMBER:

NAME OF SUBMITTER: Tameka Dash

Total Attachments: 2

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PATENT

REEL: 022413 FRAME: 0475

ASSIGNMENT

In consideration of value received, I, having a mailing address at c/o Advanced LCD Technologies Development Center Co., Ltd., 66-2, Horikawa-cho, Saiwai-ku, Kawasaki-shi, Kanagawa 212-0013 Japan, and a residence as stated below next to my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

THIN-FILM SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

said application having been filed on and assigned Application No. ; sell and assign to Advanced LCD Technologies Development Center Co., Ltd. a corporation of Japan, having a business address at 66-2, Horikawa-cho, Saiwai-ku, Kawasaki-shi, Kanagawa 212-0013 Japan

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said application for United States patent: (check one)

[X]	executed concurrently herewith
[]	executed separately herefrom;

and in and to all applications for patent and patents for said invention including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.

I hereby grant the following law firm the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Oblon, Spivak, McClelland, Maier & Neustadt, P.C., 1940 Duke Street, Alexandria, VA 22314

PATENT REEL: 022413 FRAME: 0476

ASSIGNMENT

Inventor: (Signature)

Date

Residence

MAR. - 9. 2009

Yokohama-shi, Japan

Tetsuya Ide

MAR. - 9. 2009

Yokohama-shi, Japan

PATENT REEL: 022413 FRAME: 0477

RECORDED: 03/18/2009